



[10191/1993]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Richard SPITZ et al.  
Serial No. : 09/914,404  
Filed : December 13, 2001  
For : **METHOD FOR PRODUCING HEAVILY-DOPED  
SEMICONDUCTOR COMPONENTS**  
  
Group Art Unit : 2823  
Confirmation No. : 5115  
Examiner : Michelle Estrada

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**AARON C. DEDITCH**  
(33,865)

**AMENDMENT AFTER FINAL OFFICE ACTION**

S I R:

In response to the Final Office Action mailed on May 2, 2003 (the three-month response date for which has been extended by one month from August 2, 2003 to September 2, 2003 by the accompanying Transmittal And Petition To Extend), please reconsider the above-identified application based on the following:

**Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.

**Remarks** begin on page 5 of this paper.

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